

# OdAR System: Implementation & Project Management Plan

## Executive Summary

This document outlines the comprehensive implementation plan for the OdAR (Olfactory Detection and Ranging) System, integrating all required hardware, software, and operational components. The plan details a phased approach with clear dependencies, critical paths, resource allocations, and timeline management strategies.

## Project Scope

The OdAR implementation encompasses the complete deployment of an advanced chemical detection and spatial localization system with the following core capabilities:

- Multi-compound chemical detection using a hybrid sensor array
- Spatial localization through ultrasonic ranging technology
- Real-time data processing using specialized AI models
- Environmental compensation and calibration systems
- User interface and data visualization components

## Project Organization

### Project Team Structure

Role	Responsibilities	FTE Allocation
Project Manager	Overall coordination, timeline management, stakeholder communication	1.0
Hardware Lead	Sensor array integration, electronics implementation, physical design	1.0
Software Lead	Firmware development, AI model implementation, data processing	1.0
Testing Lead	Validation protocols, quality assurance, performance verification	1.0
Manufacturing Specialist	Production setup, assembly procedures, quality control	0.5
Documentation Specialist	Technical documentation, user manuals, compliance documentation	0.5

## Steering Committee

- Executive Sponsor

- Technical Director
- Quality Assurance Manager
- Customer Representative
- Regulatory Affairs Manager

## **Implementation Timeline**

### **Phase 1: Hardware Development (Months 1-2)**

- Sensor array integration and testing
- Microcontroller system implementation
- Power management system setup
- Physical enclosure fabrication
- Component procurement and verification

### **Phase 2: Data Collection & Calibration (Months 2-3)**

- Testing chamber setup
- Reference data collection
- Sensor calibration protocol development
- Environmental testing
- Baseline performance establishment

### **Phase 3: AI Model Development (Months 3-4)**

- Feature extraction implementation
- Neural network architecture optimization
- Model training and validation
- Performance benchmarking
- Quantization and optimization

### **Phase 4: System Integration (Months 4-5)**

- Hardware-software integration
- User interface implementation
- Communication protocols setup
- Power optimization

- Initial end-to-end testing

## **Phase 5: Testing & Documentation (Months 5-6)**

- Comprehensive validation testing
- User documentation finalization
- Regulatory compliance verification
- Production preparation
- Customer acceptance testing

## **Implementation Checklist**

### **Hardware Components**

#### **Sensor Array**

- ☐ **MOS Sensors**
- ☐ 2× SnO<sub>2</sub> sensors installed
- ☐ 1× ZnO sensor installed
- ☐ 1× WO<sub>3</sub> sensor installed
- ☐ Detection range verified (5ppb to 500ppm)
- ☐ Response time validated (<1 second)
- ☐ Recovery time validated (<60 seconds)
- ☐ **Conducting Polymer Sensors**
- ☐ 2× Polyaniline (PANI) sensors installed
- ☐ 2× Polypyrrole (PPy) sensors installed
- ☐ Detection range verified (1-200ppm)
- ☐ Response time validated (<2 seconds)
- ☐ Recovery time validated (<90 seconds)

#### **Ranging System**

- ☐ **Ultrasonic Sensors**
- ☐ 3× HC-SR04 sensors installed (front, left, right)
- ☐ Range capability verified (up to 4 meters)
- ☐ Accuracy validated ( $\pm 2$  cm)
- ☐ 360° coverage confirmed
- ☐ **Optional ToF Sensor**
- ☐ VL53L1X sensor installed
- ☐ Range verified (up to 4 meters)

- ☐ Accuracy validated ( $\pm 1$  cm)

## Microcontroller System

### ☐ Processor

- ☐ ESP32-WROOM-32E module installed
- ☐ 240 MHz clock speed verified
- ☐ 4MB Flash memory confirmed
- ☐ 520KB SRAM confirmed

### ☐ Data Acquisition

- ☐ 12-bit ADC configured
- ☐ Sampling rate verified (10-100 Hz)
- ☐ Signal conditioning components installed
- ☐ Anti-aliasing filters implemented

### ☐ Temperature Control

- ☐ LM35 temperature sensor installed
- ☐ Ceramic heater (5V) mounted
- ☐ PID controller implemented
- ☐ Temperature cycling validated (10-40°C)

## Power Management

### ☐ Battery System

- ☐ 3.7V Li-Ion battery (18650 cell) installed
- ☐ 3000mAh capacity verified
- ☐ Battery Management System (BMS) configured
- ☐ Overcharge/overdischarge protection tested

### ☐ Power Regulation

- ☐ Buck-boost converter installed
- ☐ Low-noise regulator for sensors implemented
- ☐ Sleep mode configured
- ☐ Power indicators (LED) functional

## Physical Design

### ☐ Enclosure

- ☐ Polycarbonate material used
- ☐ Dimensions confirmed: 100mm × 60mm × 30mm
- ☐ IP65 rating verified
- ☐ 1.0m drop resistance validated

## ☐ **User Interface**

- ☐ 0.96" OLED display (128×64 pixels) mounted
- ☐ 3 tactile buttons installed (Menu, Select, Back)
- ☐ Status LED indicators functional
- ☐ USB-C port installed

## **Software Implementation**

### **Firmware Structure**

#### ☐ **Core Modules**

- ☐ Initialization module implemented
- ☐ Temperature control module completed
- ☐ Data acquisition module implemented
- ☐ Ranging module implemented
- ☐ Storage module completed
- ☐ User interface module implemented
- ☐ Power management module completed

#### ☐ **Multi-tasking Implementation**

- ☐ FreeRTOS configured
- ☐ Task priorities established
- ☐ Semaphore implementation completed
- ☐ Watchdog timer configured

### **AI Model Architecture**

#### ☐ **Neural Network Setup**

- ☐ CNN-LSTM hybrid model implemented
- ☐ Input shape configured
- ☐ Feature extraction layers implemented
- ☐ Temporal processing layers implemented
- ☐ Dual-head output configured

#### ☐ **Inference Engine**

- ☐ TensorFlow Lite Micro integrated
- ☐ INT8 quantization implemented
- ☐ Inference time validated
- ☐ Memory usage optimized

#### ☐ **Data Processing Pipeline**

- ☐ Pre-processing algorithms implemented
- ☐ Feature extraction completed

- ☐ Post-processing implemented
- ☐ Data fusion implemented

## **Calibration System**

### ☐ **Sensor Calibration**

- ☐ Zero calibration procedure implemented
- ☐ Span calibration procedure implemented
- ☐ Temperature compensation implemented
- ☐ Calibration storage configured

### ☐ **Ranging Calibration**

- ☐ Distance calibration completed
- ☐ Angular calibration completed
- ☐ Material compensation implemented
- ☐ Calibration interval established

## **Testing and Validation**

### **Testing Chamber Setup**

#### ☐ **Chamber Construction**

- ☐ 5.0m × 5.0m × 3.0m internal dimensions verified
- ☐ Sealed environment with airlock completed
- ☐ Non-absorptive surfaces installed
- ☐ Temperature control (0-40°C) functional
- ☐ Humidity control (20-80% RH) functional

#### ☐ **Testing Infrastructure**

- ☐ Robotic XYZ positioning system installed
- ☐ Gas delivery system implemented
- ☐ Environmental monitoring installed
- ☐ Data acquisition system configured
- ☐ Reference instruments calibrated

### **Testing Protocols**

#### ☐ **Olfactory Performance Testing**

- ☐ Compound testing protocols established
- ☐ Concentration testing completed
- ☐ Temperature impact analysis performed
- ☐ Repeatability verification completed

#### ☐ **Ranging Performance Testing**

- ☐ Static testing procedures completed
- ☐ Angular testing procedures completed
- ☐ Material testing protocols executed
- ☐ Dynamic testing performed
- ☐ **Environmental Testing**
- ☐ Temperature testing (0°C, 20°C, 40°C) completed
- ☐ Humidity testing (20%, 50%, 80%) completed
- ☐ Interference testing performed
- ☐ Long-term stability testing concluded

## Validation Results

### ☐ **Detection Performance Validation**

- ☐ Classification accuracy verified
- ☐ Concentration estimation validated
- ☐ Response time measured
- ☐ Recovery time assessed

### ☐ **Ranging Performance Validation**

- ☐ Static accuracy verified
- ☐ Angular accuracy validated
- ☐ Dynamic tracking assessed
- ☐ Multi-source discrimination tested

## Maintenance Protocols

### Routine Maintenance

#### ☐ **Daily Checks**

- ☐ Sensor intake inspection procedure documented
- ☐ Battery status verification process established
- ☐ Sensor operation check protocol developed
- ☐ Error log review procedure documented

#### ☐ **Weekly Maintenance**

- ☐ Full system test procedure documented
- ☐ Enclosure cleaning protocol established
- ☐ Seal check procedure developed
- ☐ Data backup process documented

#### ☐ **Monthly Maintenance**

- ☐ Full calibration procedure documented
- ☐ Sensor performance check protocol established

- ☐ Battery maintenance procedure developed
- ☐ Software update process documented

## **Component Replacement**

### ☐ **Sensor Replacement**

- ☐ MOS sensor replacement protocol (18-24 months) documented
- ☐ Polymer sensor replacement protocol (12-18 months) documented
- ☐ Ranging sensor replacement protocol (3-5 years) documented
- ☐ Calibration after replacement procedure established

### ☐ **Battery Maintenance**

- ☐ Health check procedure documented
- ☐ Discharge/recharge cycle protocol established
- ☐ Replacement criteria defined
- ☐ Replacement procedure documented

### ☐ **Other Components**

- ☐ Air intake filter replacement procedure documented
- ☐ Gasket set replacement protocol established
- ☐ Firmware update procedures documented
- ☐ Calibration verification process established

## **Calibration Procedures**

### ☐ **Required Equipment**

- ☐ Calibration kit specifications documented
- ☐ Reference compounds list established
- ☐ Ranging calibration kit requirements defined

### ☐ **Calibration Process**

- ☐ Zero calibration procedure documented
- ☐ Span calibration procedure documented
- ☐ Temperature cycle calibration process established
- ☐ Ranging calibration procedure documented

## **Documentation**

### **User Documentation**

#### ☐ **User Manual**

- ☐ Introduction and safety information completed
- ☐ Getting started guide written
- ☐ Basic operation instructions documented



- ☐ Advanced features guide completed
- ☐ Troubleshooting procedures documented
- ☐ **Quick Reference Cards**
- ☐ Basic operation card created
- ☐ Measurement mode card developed
- ☐ Display indicators card produced
- ☐ Error recovery card created
- ☐ Maintenance reminders card completed

## Technical Documentation

- ☐ **System Architecture**
- ☐ Complete system overview documented
- ☐ Hardware component relationships described
- ☐ Software architecture diagrams created
- ☐ Signal processing pipeline documented
- ☐ Power management system described
- ☐ **Technical Drawings**
- ☐ Mechanical drawings completed
- ☐ PCB layout diagrams finalized
- ☐ Wiring schematics documented
- ☐ Component placement diagrams created
- ☐ Testing chamber blueprints finalized
- ☐ **Performance Specifications**
- ☐ Detection capabilities documented
- ☐ Ranging performance specifications defined
- ☐ Power performance details documented
- ☐ Environmental specifications established

## Compliance Documentation

- ☐ **Test Reports**
- ☐ Performance test reports completed
- ☐ Environmental test reports finalized
- ☐ EMC test reports obtained
- ☐ Safety test reports documented
- ☐ **Certification Documents**
- ☐ CE certification obtained
- ☐ FCC certification obtained

- ☐ RoHS compliance documented
- ☐ IP65 certification verified
- ☐ Safety standard compliance confirmed

## Manufacturing Integration

### Production Setup

- ☐ **Component Sourcing**
- ☐ Sensor suppliers identified and contracted
- ☐ Electronics components sourcing established
- ☐ Mechanical parts suppliers selected
- ☐ Enclosure materials sourcing confirmed
- ☐ **Assembly Process**
- ☐ PCB assembly procedure documented
- ☐ Sensor array installation process defined
- ☐ Temperature control system assembly procedure established
- ☐ Enclosure assembly process documented

### Quality Control

- ☐ **Testing Procedures**
- ☐ Functional testing protocol established
- ☐ Calibration verification process defined
- ☐ Environmental testing procedure documented
- ☐ Performance validation process established
- ☐ **Quality Metrics**
- ☐ Detection accuracy standards defined
- ☐ Ranging accuracy requirements established
- ☐ Battery life verification process developed
- ☐ Durability testing procedure documented

### Support Infrastructure

- ☐ **Technical Support**
- ☐ Support documentation completed
- ☐ Troubleshooting guides developed
- ☐ Repair procedures documented
- ☐ Contact information established
- ☐ **Training Materials**
- ☐ Operator training modules developed

- ☐ Maintenance technician certification program created
- ☐ Advanced troubleshooting courses designed
- ☐ Calibration specialist training materials completed

## **Project Management**

### **Timeline Management**

- ☐ **Development Phases**
- ☐ Hardware development (Months 1-2) timeline established
- ☐ Data collection (Months 2-3) schedule defined
- ☐ AI development (Months 3-4) timeline set
- ☐ System integration (Months 4-5) schedule established
- ☐ Testing & documentation (Months 5-6) timeline confirmed

### **Budget Tracking**

- ☐ **Budget Categories**
- ☐ Hardware (\$85,000) allocation planned
- ☐ Software development (\$90,000) budget established
- ☐ Expert consulting (\$75,000) resources allocated
- ☐ Patent and documentation (\$25,000) budget set

### **Risk Management**

- ☐ **Risk Assessment**
- ☐ Technology integration risk mitigation plan developed
- ☐ Sensor performance risk management strategy established
- ☐ AI model performance risk handling procedures defined
- ☐ Budget overrun risk control measures implemented

## **Additional Integration Considerations**

### **Nanofiber Sensor Enhancement**

- ☐ **Feasibility Assessment**
- ☐ Performance benefit analysis completed
- ☐ Integration complexity evaluated
- ☐ Cost-benefit analysis performed
- ☐ Timeline impact assessed
- ☐ **Implementation Planning**
- ☐ Electrospinning process defined

- ☐ Material selection completed
- ☐ Integration method determined
- ☐ Signal processing adaptation planned

**Software Infrastructure Enhancement**

- ☐ **Cloud Integration**
  - ☐ Architecture design completed
  - ☐ Security protocols established
  - ☐ Data management system defined
  - ☐ API development planned
- ☐ **Remote Update Mechanism**
  - ☐ Update package management system designed
  - ☐ Deployment infrastructure planned
  - ☐ Device-side implementation defined
  - ☐ Security measures established

**Approvals and Sign-offs**

Role	Name	Signature	Date
Project Manager			
Technical Director			
Quality Assurance Manager			
Executive Sponsor			